

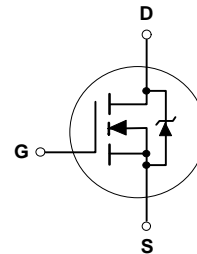
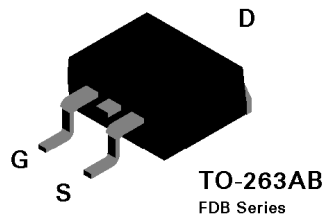
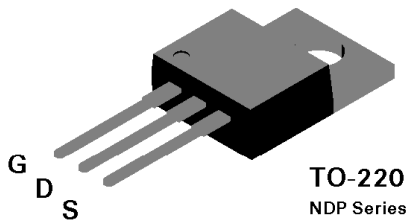
## NDP7060 / NDB7060 N-Channel Enhancement Mode Field Effect Transistor

### General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as automotive, DC/DC converters, PWM motor controls, and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

### Features

- 75A, 60V.  $R_{DS(ON)} = 0.013\Omega @ V_{GS}=10V$ .
- Critical DC electrical parameters specified at elevated temperature.
- Rugged internal source-drain diode can eliminate the need for an external Zener diode transient suppressor.
- 175°C maximum junction temperature rating.
- High density cell design for extremely low  $R_{DS(ON)}$ .
- TO-220 and TO-263 (D<sup>2</sup>PAK) package for both through hole and surface mount applications.



### Absolute Maximum Ratings $T_c = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	NDP7060	NDB7060	Units
$V_{DSS}$	Drain-Source Voltage	60		V
$V_{DGR}$	Drain-Gate Voltage ( $R_{GS} \leq 1\text{ M}\Omega$ )	60		V
$V_{GSS}$	Gate-Source Voltage - Continuous	$\pm 20$		V
	- Nonrepetitive ( $t_p < 50\ \mu\text{s}$ )	$\pm 40$		
$I_D$	Drain Current - Continuous	75		A
	- Pulsed	225		
$P_D$	Maximum Power Dissipation @ $T_c = 25^\circ\text{C}$	150		W
	Derate above $25^\circ\text{C}$	1		
$T_J, T_{STG}$	Operating and Storage Temperature Range	-65 to 175		$^\circ\text{C}$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	275		$^\circ\text{C}$

**Electrical Characteristics** ( $T_c = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>DRAIN-SOURCE AVALANCHE RATINGS</b> (Note 1)						
$W_{DSS}$	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = 25\text{ V}, I_D = 75\text{ A}$			550	mJ
$I_{AR}$	Maximum Drain-Source Avalanche Current				75	A
<b>OFF CHARACTERISTICS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	60			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$			250	$\mu\text{A}$
			$T_J = 125^\circ\text{C}$		1	mA
$I_{GSSF}$	Gate - Body Leakage, Forward	$V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$			100	nA
$I_{GSSR}$	Gate - Body Leakage, Reverse	$V_{GS} = -20\text{ V}, V_{DS} = 0\text{ V}$			-100	nA
<b>ON CHARACTERISTICS</b> (Note 1)						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2	2.8	4	V
			$T_J = 125^\circ\text{C}$	1.4	2.1	
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 40\text{ A}$		0.01	0.013	$\Omega$
			$T_J = 125^\circ\text{C}$		0.015	
$I_{D(on)}$	On-State Drain Current	$V_{GS} = 10\text{ V}, V_{DS} = 10\text{ V}$	75			A
$g_{FS}$	Forward Transconductance	$V_{DS} = 10\text{ V}, I_D = 37.5\text{ A}$	15	39		S
<b>DYNAMIC CHARACTERISTICS</b>						
$C_{ISS}$	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$		2960	3600	pF
$C_{OSS}$	Output Capacitance			1130	1600	
$C_{RSS}$	Reverse Transfer Capacitance			380	800	
<b>SWITCHING CHARACTERISTICS</b> (Note 1)						
$t_{D(on)}$	Turn - On Delay Time	$V_{DD} = 30\text{ V}, I_D = 75\text{ A},$ $V_{GS} = 10\text{ V}, R_{GEN} = 5\text{ }\Omega$		17	30	nS
$t_r$	Turn - On Rise Time			128	400	
$t_{D(off)}$	Turn - Off Delay Time			54	80	
$t_f$	Turn - Off Fall Time			90	200	
$Q_g$	Total Gate Charge	$V_{DS} = 48\text{ V},$ $I_D = 75\text{ A}, V_{GS} = 10\text{ V}$		100	115	nC
$Q_{gs}$	Gate-Source Charge			14.5		
$Q_{gd}$	Gate-Drain Charge			51		

**Electrical Characteristics** ( $T_c = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>DRAIN-SOURCE DIODE CHARACTERISTICS</b>						
$I_S$	Maximum Continuous Drain-Source Diode Forward Current				75	A
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current				225	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}$ , $I_S = 37.5\text{ A}$ (Note 1)		0.9	1.3	V
			$T_J = 125^\circ\text{C}$	0.84	1.2	
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0\text{ V}$ , $I_F = 75\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$	40	76	150	ns
$I_{rr}$	Reverse Recovery Current		2	4.7	10	A
<b>THERMAL CHARACTERISTICS</b>						
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case				1	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient				62.5	$^\circ\text{C}/\text{W}$

Note:

1. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

## Typical Electrical Characteristics

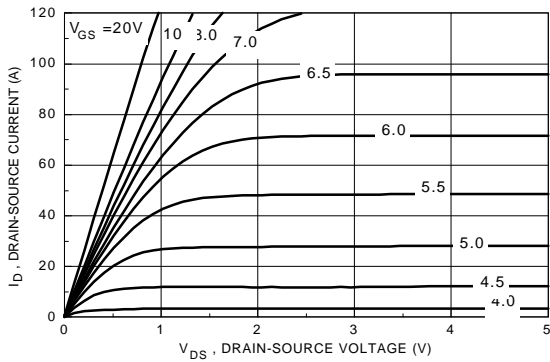


Figure 1. On-Region Characteristics

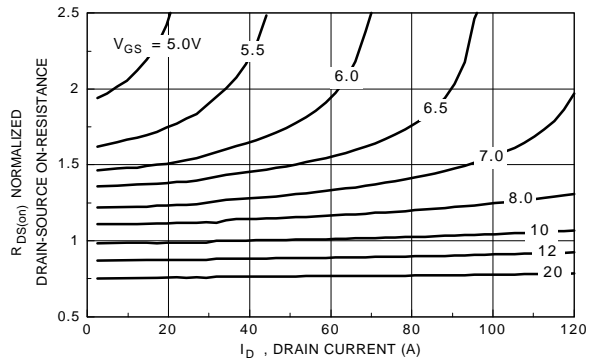


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current

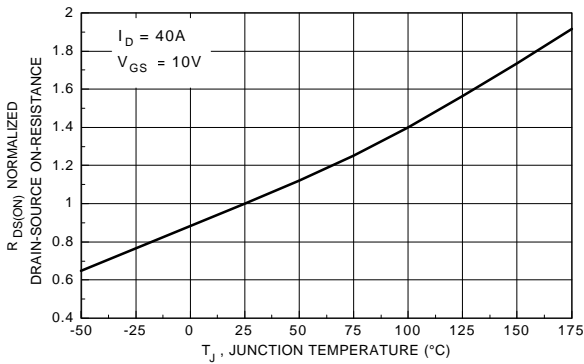


Figure 3. On-Resistance Variation with Temperature

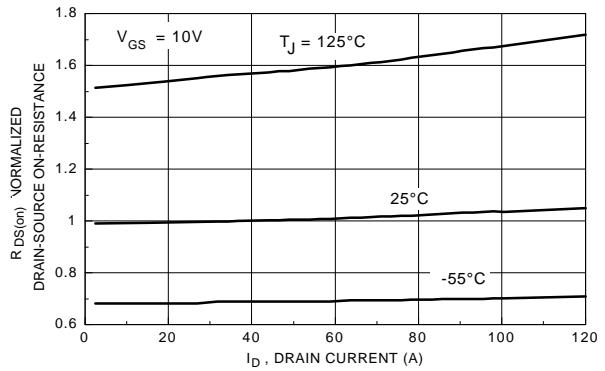


Figure 4. On-Resistance Variation with Drain Current and Temperature

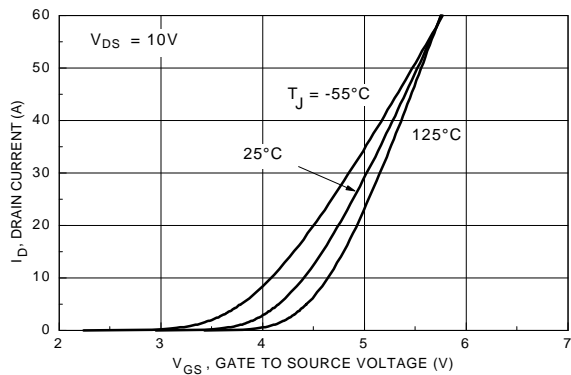


Figure 5. Transfer Characteristics

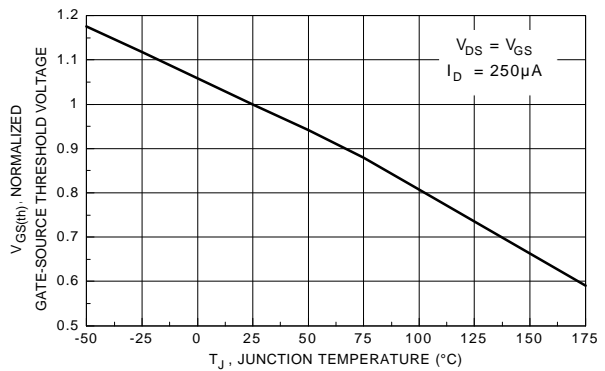
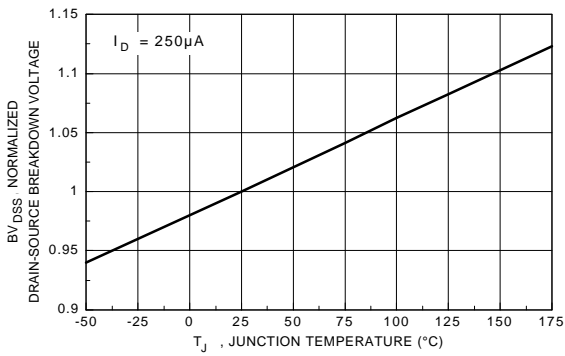
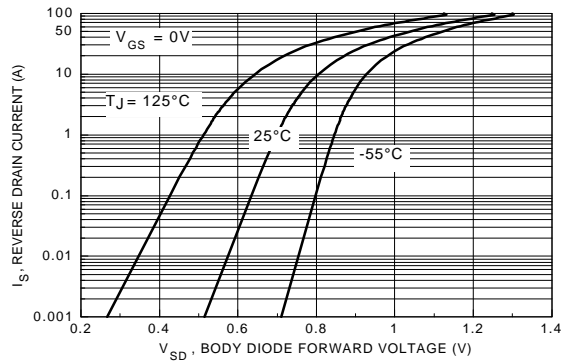


Figure 6. Gate Threshold Variation with Temperature

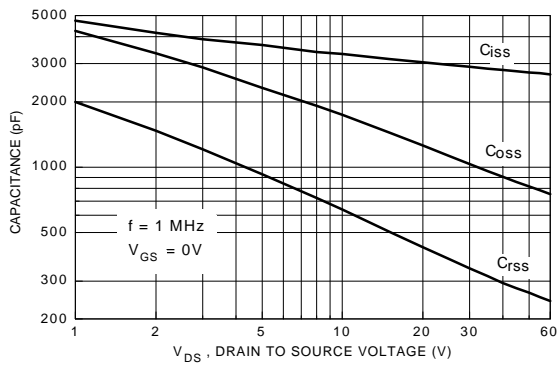
## Typical Electrical Characteristics (continued)



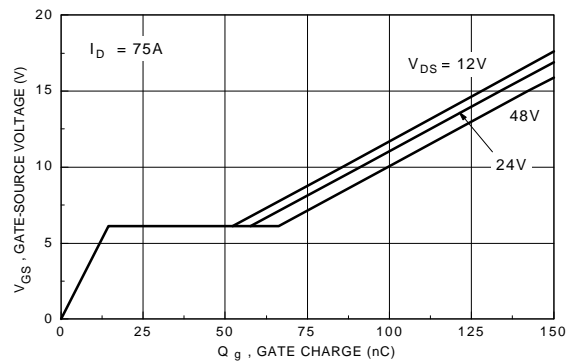
**Figure 7. Breakdown Voltage Variation with Temperature**



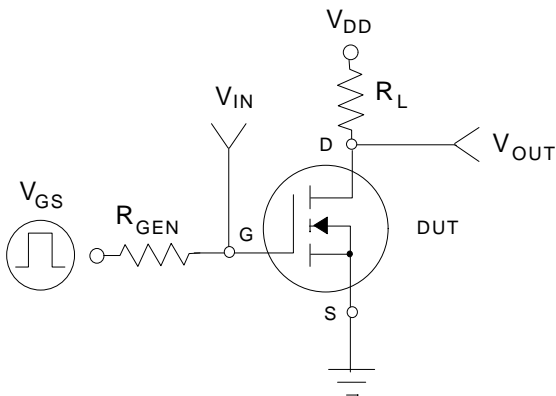
**Figure 8. Body Diode Forward Voltage Variation with Current and Temperature**



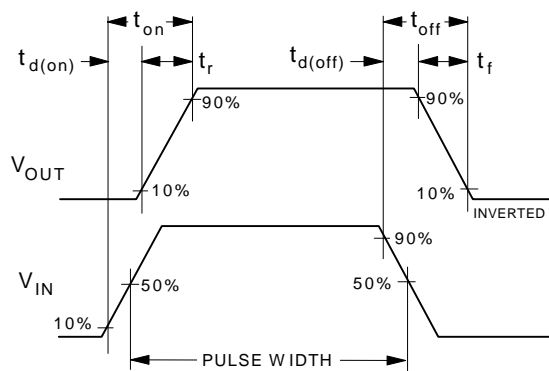
**Figure 9. Capacitance Characteristics**



**Figure 10. Gate Charge Characteristics**



**Figure 11. Switching Test Circuit**



**Figure 12. Switching Waveforms**

### Typical Electrical Characteristics (continued)

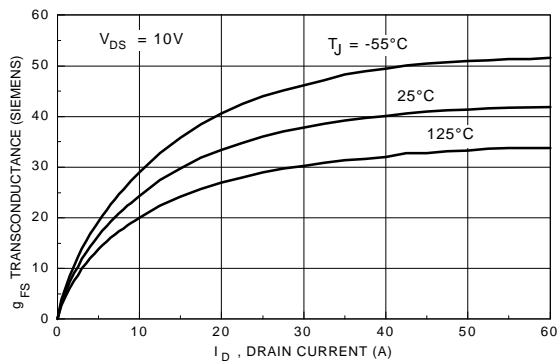


Figure 13. Transconductance Variation with Drain Current and Temperature

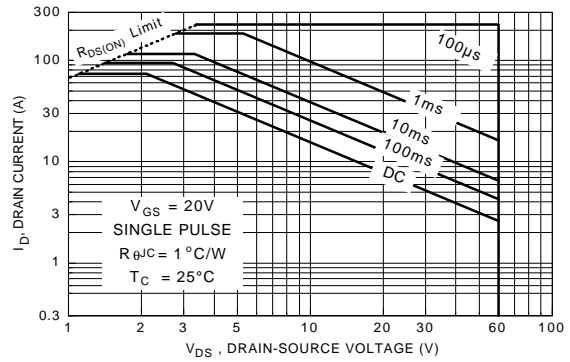


Figure 14. Maximum Safe Operating Area

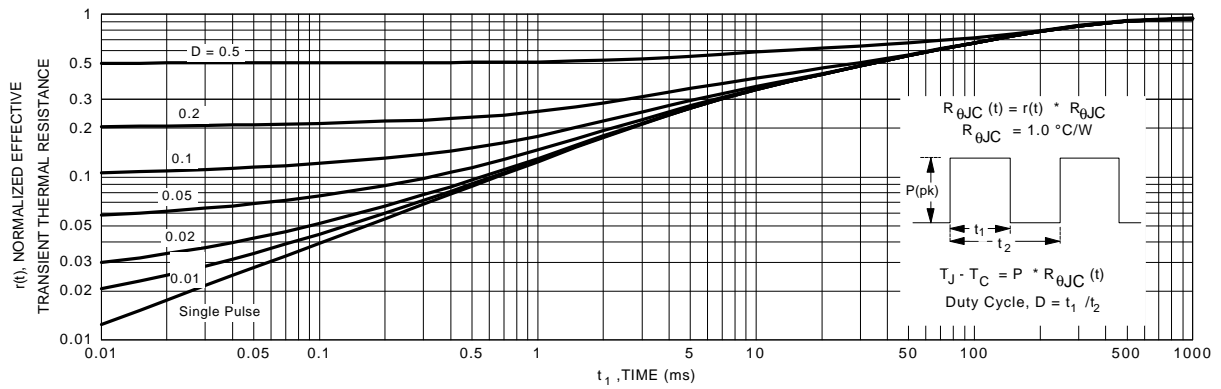
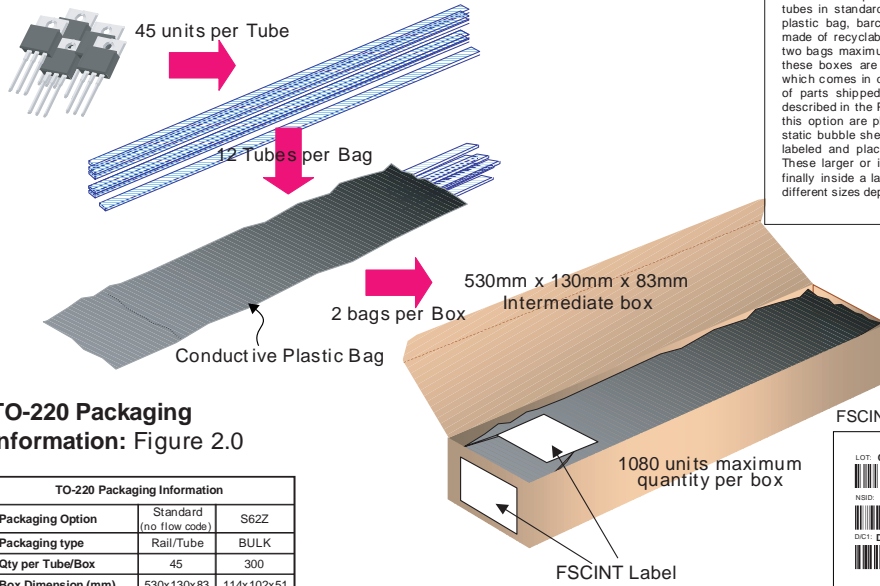


Figure 15. Transient Thermal Response Curve

# TO-220 Tape and Reel Data and Package Dimensions



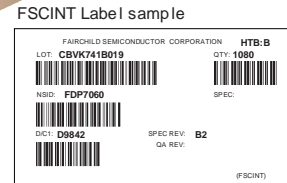
## TO-220 Tube Packing Configuration: Figure 1.0



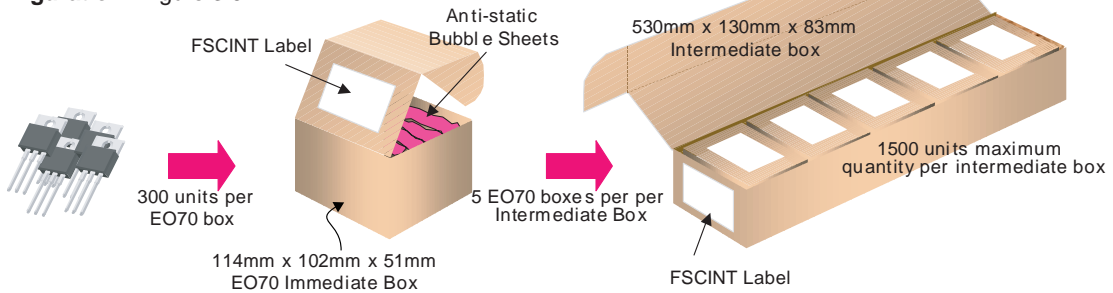
**Packaging Description:**  
 TO-220 parts are shipped normally in tube. The tube is made of PVC plastic treated with anti-static agent. These tubes in standard option are placed inside a dissipative plastic bag, barcode labeled, and placed inside a box made of recyclable corrugated paper. One box contains two bags maximum (see fig. 1.0). And one or several of these boxes are placed inside a labeled shipping box which comes in different sizes depending on the number of parts shipped. The other option comes in bulk as described in the Packaging Information table. The units in this option are placed inside a small box laid with anti-static bubble sheet. These smaller boxes are individually labeled and placed inside a larger box. (See fig. 3.0). These larger or intermediate boxes then will be placed finally inside a labeled shipping box which still comes in different sizes depending on the number of units shipped.

## TO-220 Packaging Information: Figure 2.0

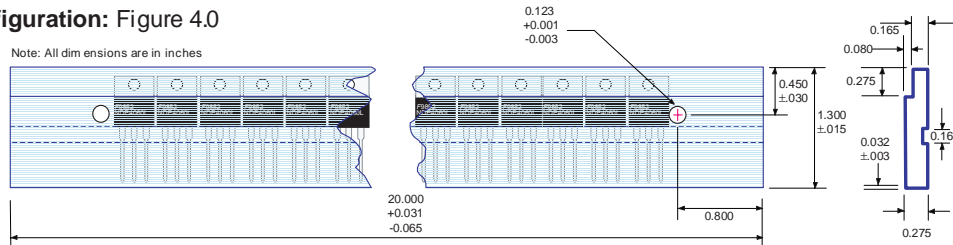
TO-220 Packaging Information		
Packaging Option	Standard (no flow code)	S62Z
Packaging type	Reel/Tube	BULK
Qty per Tube/Box	45	300
Box Dimension (mm)	530x130x83	114x102x51
Max qty per Box	1,080	1,500
Weight per unit (gm)	1.4378	1.4378
Note/Comments		



## TO-220 bulk Packing Configuration: Figure 3.0



## TO-220 Tube Configuration: Figure 4.0



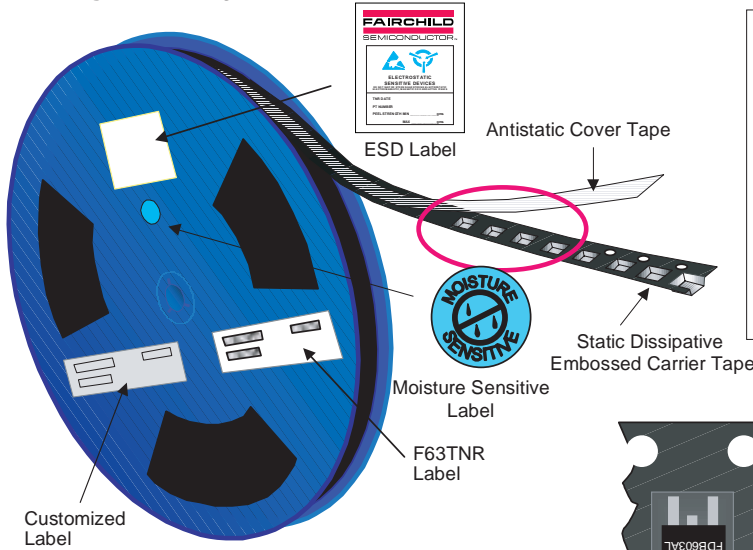




# TO-263AB/D<sup>2</sup>PAK Tape and Reel Data and Package Dimensions

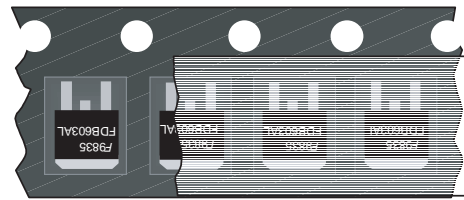


## TO-263AB/D<sup>2</sup>PAK Packaging Configuration: Figure 1.0

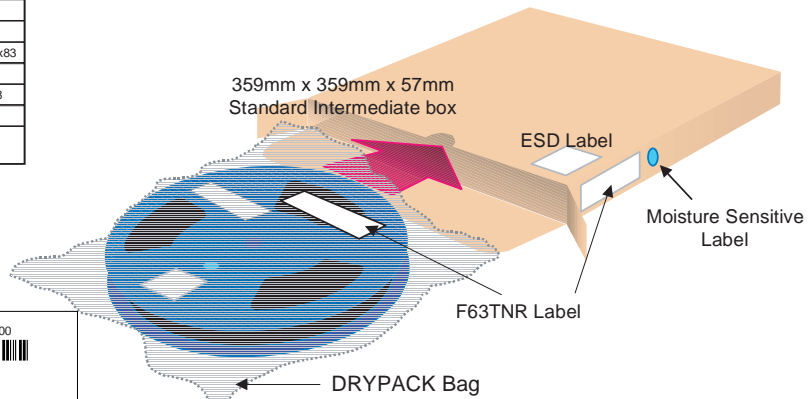


**Packaging Description:**  
 TO-263/D<sup>2</sup>PAK parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 800 units per 13" or 330cm diameter reel. The reels are dark blue in color and is made of polystyrene plastic (anti-static coated). This and some other options are further described in the Packaging Information table.  
 These full reels are individually barcode labeled, dry packed, and placed inside a standard intermediate box (illustrated in figure 1.0) made of recyclable corrugated brown paper. One box contains one reel maximum. And these boxes are placed inside a barcode labeled shipping box which comes in different sizes depending on the number of parts shipped.

TO-263AB/D <sup>2</sup> PAK Packaging Information		
Packaging Option	Standard (no flow code)	L86Z
Packaging type	TNR	Rail/Tube
Qty per Reel/Tube/Bag	800	45
Reel Size	13" Dia	-
Box Dimension (mm)	359x359x57	530x130x83
Max qty per Box	800	1,080
Weight per unit (gm)	1.4378	1.4378
Weight per Reel	1.6050	-
Note/Comments		



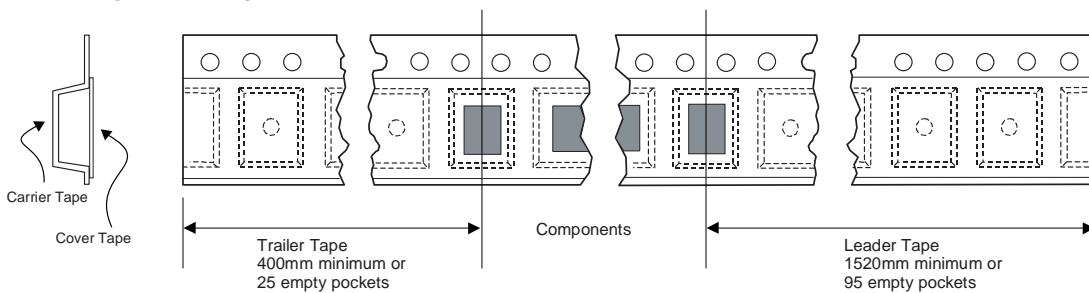
TO-263AB/D<sup>2</sup>PAK Unit Orientation



### F63TNR Label sample

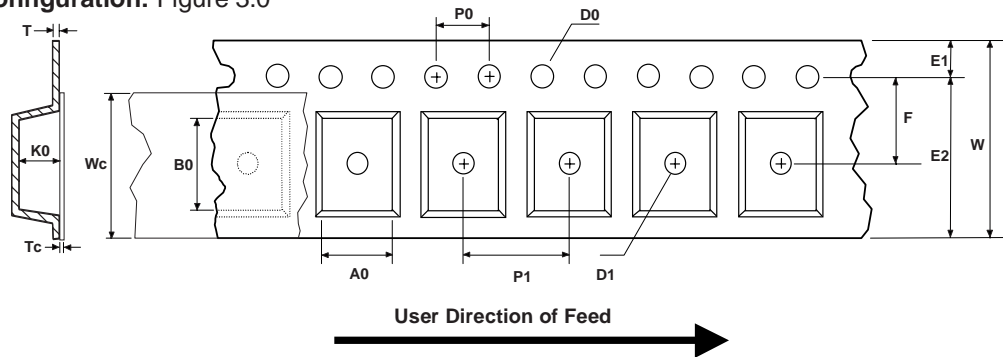


## TO-263AB/D<sup>2</sup>PAK Tape Leader and Trailer Configuration: Figure 2.0



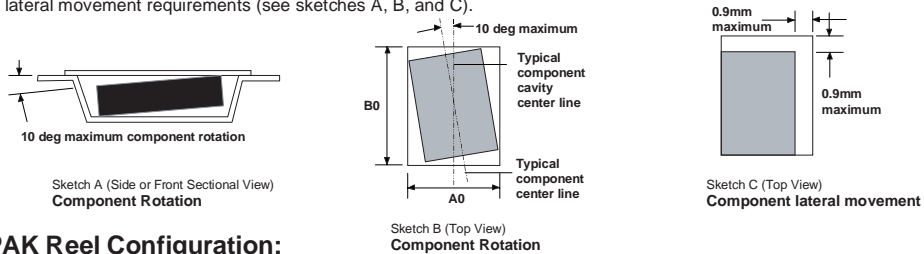
# TO-263AB/D<sup>2</sup>PAK Tape and Reel Data and Package Dimensions, continued

## TO-263AB/D<sup>2</sup>PAK Embossed Carrier Tape Configuration: Figure 3.0

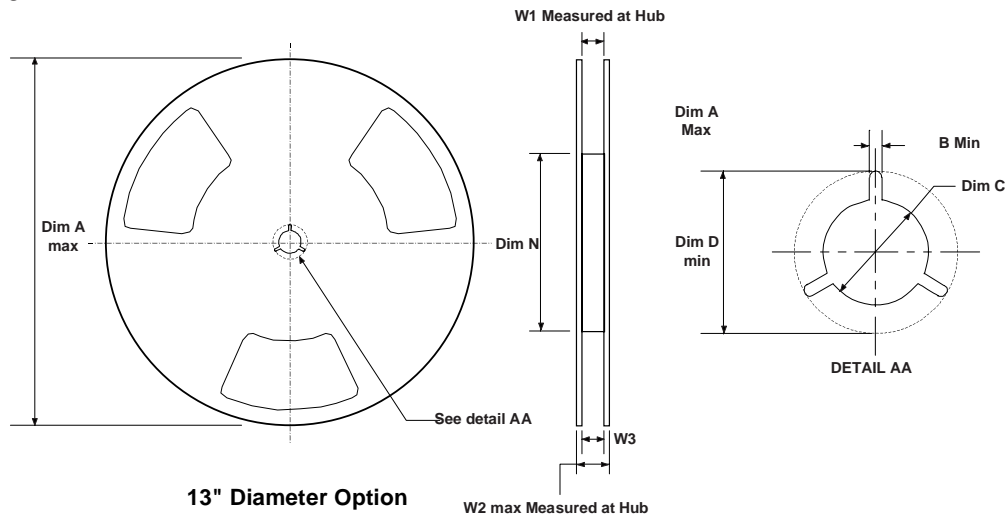


Dimensions are in millimeter														
Pkg type	A0	B0	W	D0	D1	E1	E2	F	P1	P0	K0	T	Wc	Tc
TO263AB/ D <sup>2</sup> PAK (24mm)	10.60 +/-0.10	15.80 +/-0.10	24.0 +/-0.3	1.55 +/-0.05	1.60 +/-0.10	1.75 +/-0.10	22.25 min	11.50 +/-0.10	16.0 +/-0.1	4.0 +/-0.1	4.90 +/-0.10	0.450 +/-0.150	21.0 +/-0.3	0.06 +/-0.02

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



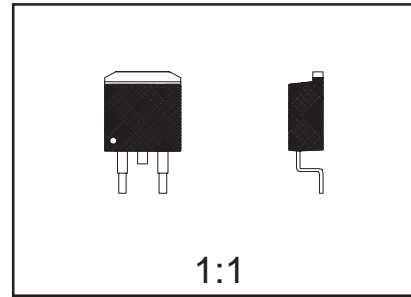
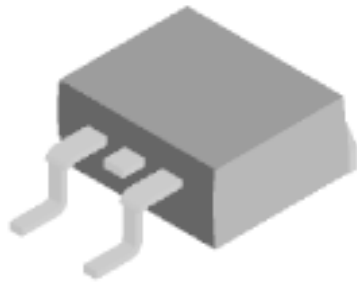
## TO-263AB/D<sup>2</sup>PAK Reel Configuration: Figure 4.0



Dimensions are in inches and millimeters									
Tape Size	Reel Option	Dim A	Dim B	Dim C	Dim D	Dim N	Dim W1	Dim W2	Dim W3 (LSL-USL)
24mm	13" Dia	13.00 330	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	4.00 100	0.961 +0.078/-0.000 24.4 +2/0	1.197 30.4	0.941 - 0.1.079 23.9 - 27.4

TO-263AB/D<sup>2</sup>PAK Tape and Reel Data and Package Dimensions, continued

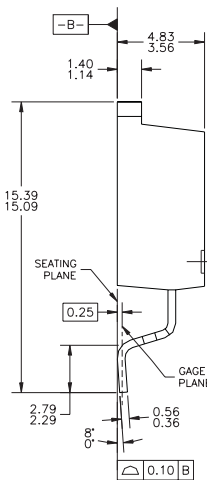
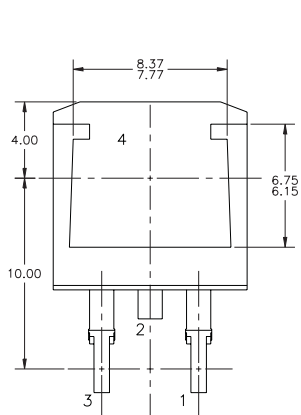
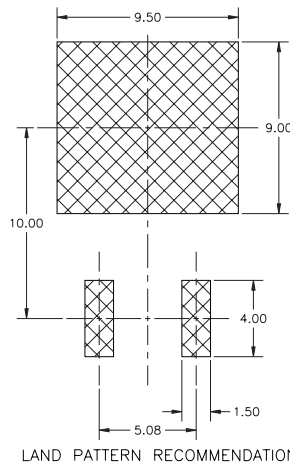
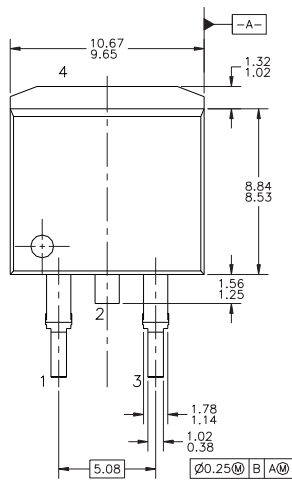
TO-263AB/D<sup>2</sup>PAK (FS PKG Code 45)



Scale 1:1 on letter size paper

Dimensions shown below are in:  
inches [millimeters]

Part Weight per unit (gram): 1.4378



- NOTES: UNLESS OTHERWISE SPECIFIED  
 A) ALL DIMENSIONS ARE IN MILLIMETERS.  
 B) STANDARD LEAD FINISH:  
 200 MICROINCHES / 5.08 MICROMETERS MIN.  
 LEAD/TIN 15/85 ON OLIN 194 COPPER OR  
 EQUIVALENT.  
 C) MAXIMUM VERTICAL BURR ON HEATSINK NOT  
 TO EXCEED 0.003 INCH / 0.05mm.  
 D) NO PACKAGE CHIPS, CRACKS OR SURFACE  
 IDENTIFICATION ALLOWED AFTER FORMING.  
 E) REFERENCE JEDEC, TO-263, ISSUE C,  
 VARIATION AB, DATED 2/92.

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CoolFET™	MICROWIRE™	TinyLogic™
CROSSVOLT™	POP™	UHC™
E <sup>2</sup> CMOS™	PowerTrench®	VCX™
FACT™	QFET™	
FACT Quiet Series™	QS™	
FAST®	Quiet Series™	
FASTr™	SuperSOT™-3	
GTO™	SuperSOT™-6	
HiSeC™	SuperSOT™-8	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## PRODUCT STATUS DEFINITIONS

### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.